Datasheet revision 1.0 <u>www.chipquik.com</u>

# Solder Wire SAC305 Rosin Activated with 2.0% Flux Core 4oz Spool

### **Product Highlights**

#### RA (Rosin Activated)

2.0% Flux Core

A stronger activated flux for hard to solder surfaces

RoHS II and REACH compliant

### **Specifications**

Alloy: Sn96.5/Ag3.0/Cu0.5
Wire Diameter: 0.015" (0.38mm)
Flux Type: Rosin Activated

Flux Classification: ROM0

Melting Point: 217-220°C (423-428°F)

Packaging: 4 oz spool

#### **Test Results**

Test J-STD-004 or other requirements as stated	Test Requirement	Result
Copper Mirror	IPC-TM-650: 2.3.32	L: No breakthrough
Corrosion	IPC-TM-650: 2.6.15	M: Slight corrosion
Quantitative Halides	IPC-TM-650: 2.3.28.1	L: <0.05%
Electrochemical Migration	IPC-TM-650: 2.6.14.1	L: <1 decade drop (No-clean)
Surface Insulation Resistance 85°C, 85% RH @ 168 Hours	IPC-TM-650: 2.6.3.7	L: ≥100MΩ (No-clean)
Visual	IPC-TM-650: 3.4.2.5	Clear and free from precipitation
Conflict Minerals Compliance	Electronic Industry Citizenship Coalition (EICC)	Compliant
REACH Compliance	Articles 33 and 67 of Regulation (EC) No 1907/2006	Contains no substance >0.1% w/w that is listed as a SVHC or restricted for use in solder materials

## **Conforms to the following Industry Standards:**

J-STD-004B, Amendment 1 (Solder Fluxes):

J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders):

Yes

RoHS 2 Directive 2011/65/EU:

Yes